# LNJ026X8ARA

Surface Mounting Chip LED

UTSS Type

#### Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit	
Power dissipation	P <sub>D</sub>	40	mW	
Forward current	$I_{\rm F}$	10	mA	
Pulse forward current *	I <sub>FP</sub>	40	mA	
Reverse voltage	V <sub>R</sub>	5	V	
Operating ambient temperature	T <sub>opr</sub>	-30 to +85	°C	
Storage temperature	T <sub>stg</sub>	-40 to +100	°C	

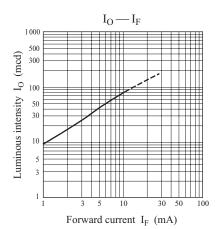
Lighting Color

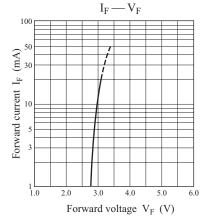
• White

Note) \*: The condition of  $I_{FP}$  is duty 10%, Pulse width 1 msec.

#### Electro-Optical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity	Io	$I_F = 5 \text{ mA}$	24	40	81	mcd
Reverse current	I <sub>R</sub>	$V_R = 5 V$			10	μΑ
Forward voltage	V <sub>F</sub>	$I_F = 5 \text{ mA}$		2.9	3.2	V
Chromaticity coordinates	х	$I_{\rm F} = 5  {\rm mA}$	0.229		0.302	
	у	$I_F = 5 \text{ mA}$	0.215		0.311	





Directive characteristics

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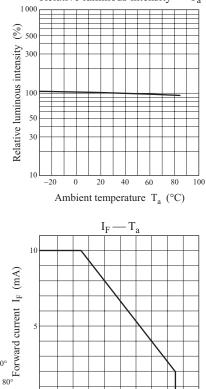
-80

-90° [ 100

80

-60





Relative luminous intensity (%)

\_\_] 90° 100

60

0 L 0

20

40

Ambient temperature Ta (°C)

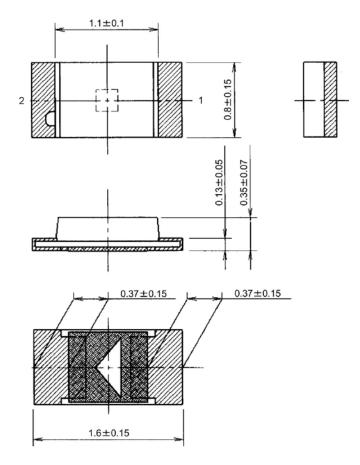
60

100

80

Package (Unit: mm)

### KLTFTN2K2600



• Pin name

1: Anode 2: Cathode

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